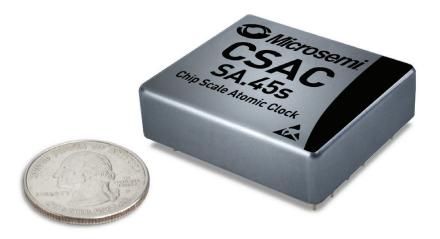


Chip-Scale Atomic Clock



Microsemi invented portable atomic timekeeping with the world's first family of miniature and chip scale atomic clocks.

Choose CSAC for best-in-class stability, size, weight, and power consumption.



Features

- Power consumption <120 mW
- Less than 17 cc volume, 1.6" × 1.39" × 0.45"
- 10 MHz CMOS-compatible output
- 1PPS output and 1PPS input for synchronization
- RS-232 interface for monitoring and control
- Short term stability (Allan Deviation) of 3.0×10^{-10} at $\tau = 1$ sec

Applications¹

- GPS receivers
- Backpack radios
- Anti-IED jamming systems
- Autonomous sensor networks
- Unmanned vehicles
- Underwater sensor systems
- Stability for various other communication and transmission applications

¹The CSAC is not tested, qualified, or rated for space applications.

With an extremely low power consumption of <120 mW and a volume of <17 cc, the Microsemi SA.45s Chip Scale Atomic Clock (CSAC) brings the accuracy and stability of an atomic clock to portable applications for the first time.

The SA.45s provides RF and 1PPS outputs at standard CMOS levels, with short-term stability (Allan Deviation) of 3.0×10^{-10} at $\tau=1$ sec, typical long-term aging of $<9\times10^{-10}$ /month, and maximum frequency change of $\pm5\times10^{-10}$ over an operating temperature range of -10 °C to 70 °C.

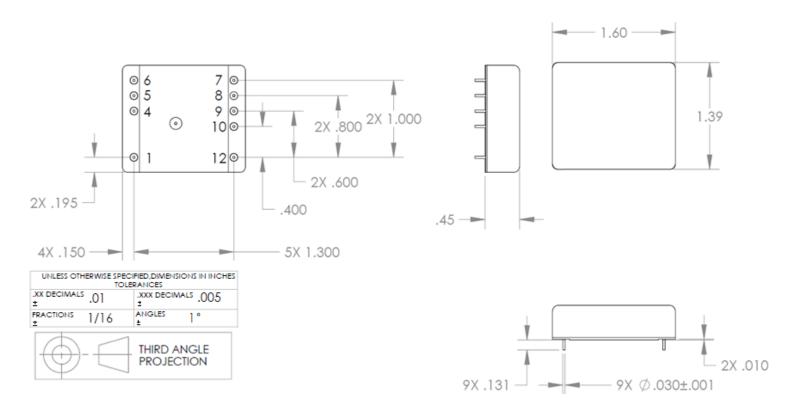
The SA.45s CSAC accepts a 1PPS input that may be used to synchronize the unit's 1PPS output to an external reference clock with ± 100 ns accuracy. It also uses the 1PPS input to discipline its phase and frequency to within 1 ns and 1.0×10^{-12} , respectively.

A standard CMOS-level RS-232 serial interface is built in to the SA.45s. This is used to control and calibrate the unit and also to provide a comprehensive set of status monitors. The interface is also used to set and read the CSAC's internal time-of-day clock.



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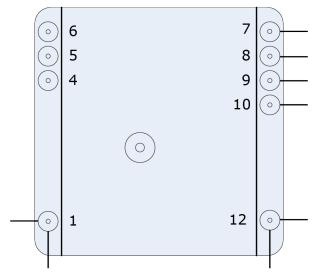
Mechanical Interface



Pin Description

Pin Number	I.D.
1	Tune
2	N/A
3	N/A
4	BITE
5	Tx
6	Rx
7	Vcc
8	GND
9	1PPS IN
10	1PPS OUT
11	N/A
12	RF OUT

Bottom View





Chip-Scale Atomic Clock

Specifications¹

Electrical

RF Output

 Frequency 10 MHz (option 001)

16.384 MHz (option 003)

 Format **CMOS** Amplitude 0 V to Vcc Load impedance 1 MO

1PPS Output

Quantity

 Rise/fall time <10 ns

(10%-90%) at load capacitance 10 pF

 Pulse width 100 µs (Option 001)

97.656 µs (Option 003)

 Level 0 V to Vcc • Logic high (VoH) min 2.80 V

 Logic low (VoL) max 0.30 V Load impedance 1 ΜΩ

 Quantity 1

1PPS Input

 Format Rising edge Low level < 0.5 V High level 2.5 V to Vcc

• Input impedance 1 ΜΩ Quantity

Serial Communications

 Protocol RS-232

CMOS 0 V to Vcc Format

• Tx/Rx impedance 1 ΜΩ 57600 Baud rate

Built-in Test Equipment (BITE) Output

 Format CMOS 0 V to Vcc

 Load impedance 1 MO

 Logic 0 = Normal operation

1 = Alarm

Power Input

 Operating <120 mW Warmup <140 mW • Input voltage (Vcc) $3.3 \pm 0.1 \, \text{V}_{DC}$

Environmental

 Operating temperature -10 °C to 70 °C $\pm 5 \times 10^{-10}$

 Maximum frequency change over operating temp range (maximum rate of change 0.5 °C

per minute)

 Frequency change over $\pm 4 \times 10^{-10}$

allowable input voltage

range

 Magnetic sensitivity $\pm 9 \times 10^{-11}$ /Gauss

(≤2.0 Gauss)

 Radiated emissions Compliant to FCC part 15.

Class B, when mounted properly

onto host PCB

 Vibration Maintains lock under

MIL-STD-810, Method 514.5,

Procedure 1, 7.7 grms

 Humidity 0%-95% RH per MIL-STD-810,

Method 507.4

Storage and Transport (Non-operating)

-55 °C to 85 °C Temperature

 Vibration MIL-STD-810, Method 514.5,

Procedure 1, 7.7 grms

• Shock (1 ms half-sine) 1000 g

Performance Parameters

 Warm-up time <180 s

Range: $\pm 2.2 \times 10^{-8}$ Analog tuning

Resolution: 1×10^{-11}

Input: 0 V-2.5 V into 100 k Ω

Range: $\pm 1 \times 10^{-6}$ Digital tuning

Resolution: 1×10^{-12}

Phase Noise (SSB)

Frequency	Option 001	Option 003
1 Hz	<-50 dBc/Hz	<-46 dBc/Hz
10 Hz	<-70 dBc/Hz	<-66 dBc/Hz
100 Hz	<-113 dBc/Hz	<-110 dBc/Hz
1 kHz	<-128 dBc/Hz	<-128 dBc/Hz
10 kHz	<-135 dBc/Hz	<-135 dBc/Hz
100 kHz	<-140 dBc/Hz	<-140 dBc/Hz

Frequency Accuracy

 Maximum offset at $\pm 5 \times 10^{-11}$ shipment

 Maximum retrace (48 hrs off)

 $\pm 5 \times 10^{-10}$

• 1PPS sync ±100 ns



Chip-Scale Atomic Clock

Aging

Type ²	SA.45s ³
Monthly	<9 × 10 ⁻¹⁰
Yearly	<1 × 10 ⁻⁸

²After 30 days of continuous operation.

³All CSAC units are tested for aging specs as per the datasheet and meet the specs at the time of shipment. However, continuous operation of CSAC over extended period of time may yield unpredictable aging performance, resulting in failure to meet the aging specs and may not be suitable for certain applications.

Short-Term Stability (Allan Deviation)

Туре	SA.45s
$\tau = 1 \text{ s}$	3×10^{-10}
τ = 10 s	1 × 10 ⁻¹⁰
τ = 100 s	3 × 10 ⁻¹¹
$\tau = 1000 \text{ s}$	1 × 10 ⁻¹¹

Physical

Weight <35 g (<1.23 oz)
Size 1.6" x 1.39" x 0.45"
MTBF >100,000 hours

Note: RoHS-compliant versions of CSAC are available with base part number 090-03240-xxx.

Solder

Hand solder using 63/37 tin/lead solder with maximum soldering tip of 329 $^{\circ}$ C (625 $^{\circ}$ F).

Ordering Information

Part Number	Description	Output Frequency
090-02984-001	Chip-scale atomic clock option 001	10 MHz
090-02984-003	Chip-scale atomic clock option 003	16.384 MHz



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